

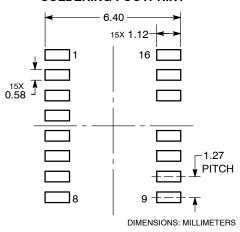
## **DATE 20 AUG 2007**

## NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE & DIMENSION AT MAXIMUM MATERIAL CONDITION.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
  MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

	MILLIMETERS		
DIM	MIN	MAX	
Α	1.35	1.75	
A1	0.10	0.25	
b	0.35	0.49	
С	0.19	0.25	
D	9.80	10.00	
E	3.80	4.00	
е	1.27 BSC		
Н	5.80	6.20	
h	0.25	0.50	
L	0.40	1.25	
M	0°	7°	

## **SOLDERING FOOTPRINT**



## **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code Α

= Assembly Location

= Wafer Lot WL = Year

WW = Work Week = Pb-Free Package G

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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